1111065

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PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Talee Yu	06/12/2005
Hellen Cheng	06/12/2005

RECEIVING PARTY DATA

Name:	Semiconductor Manufacturing International (Shanghai) Corporation	
Street Address:	18 Zhang Jiang Road	
Internal Address:	Pudong New Area	
City:	Shanghai	
State/Country:	CHINA	
Postal Code:	201203	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11110655

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 021653-011600US

NAME OF SUBMITTER: Richard T. Ogawa

Total Attachments: 1

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PATENT REEL: 018387 FRAME: 0955

Attorney Docket No.: 021653-011600US

Client Reference No.: I-04-136

ASSIGNMENT OF PATENT APPLICATION

JOINT

WHEREAS, Talee Yu of 18 Zhang Jiang Rd., Pudong New Area, Shanghai, 201203 China; and Hellen Cheng of 18 Zhang Jiang Rd., Pudong New Area, Shanghai, 201203 China, hereinafter referred to as "Assignors," are the inventors of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention:

A POWER-ON SOLUTION TO AVOID CROWBAR CURRENT FOR MULTIPLE POWER SUPPLIES'

INPUTS/OUTPUTS

Date(s) of execution of Declaration:

Filing Date:

04/19/2005

Application No.:

11/110,655; and

WHEREAS, Semiconductor Manufacturing International (Shanghai) Corporation, a corporation of Peoples' Republic of China, located at 18 Zhang Jiang Rd., Pudong New Area, Shanghai, 201203 China, hereinafter referred to as "ASSIGNEE," is desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have assigned, and by these presents do assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignors had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignors further agree that they will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignors hereby authorize and request Townsend and Townsend and Crew LLP, Two Embarcadero Center, Eighth Floor, San Francisco, CA 94111-3834, to insert herein above the application number and filing date of said application when known.

IN TESTIMONY WHEREOF, Assignors have signed their names on the dates indicated.

> PATENT REEL: 018387 FRAME: 0956

RECORDED: 10/13/2006